



Himax to Showcase Industry-Leading Automotive Display and Cutting-Edge 3D Sensing Technologies at 2026 SID Vehicle Displays and Interfaces Symposium

Tainan, Taiwan, Sep. 10, 2026 – Himax Technologies, Inc. (Nasdaq: HIMX) (“Himax” or the “Company”), a leading supplier and fabless manufacturer of display drivers and other semiconductor products, today announced it will showcase its industry-leading automotive display portfolio and state-of-the-art 3D sensing technologies at the upcoming SID Vehicle Displays and Interfaces Symposium, taking place September 15 – 16, 2026 at Huntington Place in Detroit, Michigan. Organized by the Society for Information Display (SID), the symposium is one of the premier international events dedicated to automotive display and human–machine interface (HMI) technologies.

As smart vehicle interiors evolve, displays are taking on an increasingly central role, with trends toward larger sizes, greater numbers, and more diverse display configurations. Himax offers the industry’s most comprehensive automotive display IC portfolio, spanning LCD and OLED technologies, with market leadership across multiple technology segments. Himax continues to introduce solutions for increasingly diverse vehicle cabin configurations, from curved and multi-display to pillar-to-pillar designs, while addressing varying customer requirements for cost, design, and performance.

At the event, Himax will showcase its latest automotive display innovations, including:

- **Industry-Leading Automotive TDDI with High-Speed eDP Interface:** Integrates a high-speed eDP interface, touch, and display driver into a single chip to meet next-generation smart car interior demands for large-format, high-resolution, high-quality displays and responsive touch performance. This highly integrated design reduces the need for additional bridge ICs and SerDes for display signal transmission, lowers system cost and power consumption, and simplifies panel design
- **Single-Chip Design Integrating Local Dimming Into the TDDI:** Delivers higher contrast, lower system cost, and greater power efficiency, making it ideal for smaller, lower-resolution automotive displays
- **OLED Touch IC and LCD TDDI with Knob-on-Display and Capacitive Buttons:** Enables safer, more intuitive physical controls while supporting sleek, display-centric smart car interiors, in response to the growing focus on reducing driver distraction and enhancing driving safety
- **OLED Touch IC and LCD TDDI with User-Aware Touch Control:** Distinguishes between driver and passenger touch interactions through advanced waveform and frequency detection, preventing unintended cross-zone touches and enhancing driving safety
- **Groundbreaking Multi-Output Tcon:** Supports next-generation free-form, ultra-wide, and high-resolution automotive displays with high-speed eDP input, up to six LVDS outputs, resolution up to 8K × 1K, and advanced image enhancement including local dimming, edge sharpness, and high dynamic range (HDR), plus built-in automotive safety functions including fail detection, Cyclic Redundancy Check (CRC), and on-screen display (OSD)

Beyond automotive display technologies, Himax will also present a series of live demonstrations of its latest 3D sensing technologies, including:

- **Glasses-Free 3D Total Solution:** Features a hardware-based architecture that converts stereo input into low-latency, real-time glasses-free 3D output with reduced crosstalk and flicker, ideal for next-generation notebook and tablet 3D display applications
- **SLiM™ 3D Sensing Module with Head Orientation Tracking:** Delivers high-accuracy, real-time head orientation tracking at a report rate of up to 180 Hz, enabling HMI systems to identify the display or interaction zone a user is focused on and support more intuitive in-car interaction

- **3D Eye and Hand Tracking:** Features continuous 3D spatial positioning and ultralow latency to deliver precise, real-time tracking of the user's visual focus and hand movements, enabling intuitive, seamless interaction with virtual content
- **Innovative Micro- and Nano-Pattern Design and Manufacturing Services** offered through subsidiary [Himax IGI Precision Ltd](#), which delivers tailored surface and optical properties for complex 3D structures, with demonstrations featuring manufactured diffusers and replicated/electroformed components

Himax invites all interested parties to stop by our exhibition booth at 811 (Huntington Place, Detroit) to experience the Company's leading automotive display technologies and advanced 3D sensing innovations firsthand. To schedule a meeting or booth tour, please contact Himax at: parisa_lee@himax.com.tw.

About Himax Technologies, Inc.

Himax Technologies, Inc. (NASDAQ: HIMX) is a leading global fabless semiconductor solution provider dedicated to display imaging processing technologies. The Company's display driver ICs and timing controllers have been adopted at scale across multiple industries worldwide including TVs, PC monitors, laptops, mobile phones, tablets, automotive, ePaper devices, industrial displays, among others. As the global market share leader in automotive display technology, the Company offers innovative and comprehensive automotive IC solutions, including traditional driver ICs, advanced in-cell Touch and Display Driver Integration (TDDI), local dimming timing controllers (Local Dimming Tcon), Large Touch and Display Driver Integration (LTDI) and OLED display technologies. Himax is also a pioneer in tinyML visual-AI and optical technology related fields. The Company's industry-leading WiseEye™ Ultralow Power AI Sensing technology which incorporates Himax proprietary ultralow power AI processor, always-on CMOS image sensor, and CNN-based AI algorithm has been widely deployed in consumer electronics and AIoT related applications. Himax optics technologies, such as diffractive wafer level optics, LCoS microdisplays and 3D sensing solutions, are critical for facilitating emerging AR/VR/metaverse technologies. Additionally, Himax designs and provides touch controllers, OLED ICs, LED ICs, EPD ICs, power management ICs, and CMOS image sensors for diverse display application coverage. Founded in 2001 and headquartered in Tainan, Taiwan, Himax currently employs around 2,200 people from three Taiwan-based offices in Tainan, Hsinchu and Taipei and country offices in China, Korea, and the US. Himax has 2,555 patents granted and 318 patents pending approval worldwide as of June 30, 2026.

<http://www.himax.com.tw>

Forward Looking Statements

Factors that could cause actual events or results to differ materially from those described include, but are not limited to, the effect of the Covid-19 pandemic on the Company's business; general business and economic conditions and the state of the semiconductor industry; market acceptance and competitiveness of the driver and non-driver products developed by the Company; demand for end-use applications products; reliance on a small group of principal customers; the uncertainty of continued success in technological innovations; our ability to develop and protect our intellectual property; pricing pressures including declines in average selling prices; changes in customer order patterns; changes in estimated full-year effective tax rate; shortage in supply of key components; changes in environmental laws and regulations; changes in export license regulated by Export Administration Regulations (EAR); exchange rate fluctuations; regulatory approvals for further investments in our subsidiaries; our ability to collect accounts receivable and manage inventory and other risks described from time to time in the Company's SEC filings, including those risks identified in the section entitled "Risk Factors" in its Form 20-F for the year ended December 31, 2025 filed with the SEC, as may be amended.

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